

SMT inductors

SIMID series, SIMID 1210-H

Series/Type: B82422H

Date: October 2008



B82422H

SIMID 1210-H

SMD

Size 1210 (EIA) or 3225 (IEC) Rated inductance 0.1 μH to 680 μH Rated current 61 mA to 2050 mA

100k 7165

Construction

- Ferrite drum core
- Laser-welded winding
- Flame-retardant molding

Features

- Temperature range up to 150 °C
- Very high current handling capability
- Qualified to AEC-Q200
- Suitable for lead-free reflow soldering as referenced in JEDEC J-STD 020C
- RoHS-compatible

Applications

- Filtering of supply voltages, coupling, decoupling
- DC/DC converters, switch-mode power supplies
- Automotive electronics (e.g. single wire bus systems)
- Telecommunications
- Consumer and data processing equipment
- Industrial electronics

Terminals

- Base material CuSn6
- Layer composition Cu, Ag, Sn (lead-free)¹⁾
- Electro-plated

Marking

- Marking on component: Manufacturer and letter "H", L value (in μH), tolerance of L value (coded), date of manufacture (YWWD)
- Minimum data on reel: Manufacturer, ordering code, L value, quantity, date of packing

Delivery mode and packing units

- 8-mm blister tape, wound on 180-mm or 330-mm Ø reel
- Packing units:

180-mm reel: 2000 pcs./reel 330-mm reel: 7500 pcs./reel

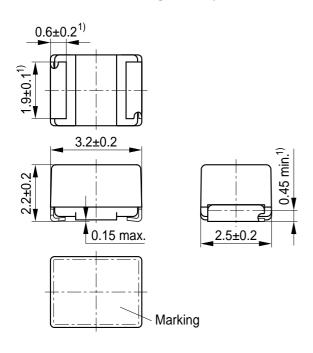
¹⁾ Ni-barrier-plated terminals on request (B82422H*50).

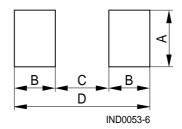
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Dimensional drawing and layout recommendation





A	В	С	D
2.7	1.15	2.1	4.4

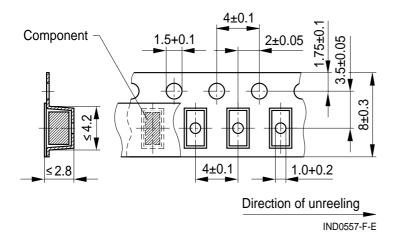
1) Soldering area

IND0496-P-E

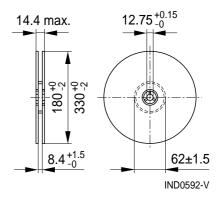
Dimensions in mm

Taping and packing

Blister tape



Reel



Dimensions in mm



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Technical data and measuring conditions

Measured with impedance analyzer Agilent 4294A at frequency f _L , 0.1 V, 20 °C				
Measured with impedance analyzer Agilent 4294A at frequency f _Q , 20 °C				
105 °C				
Maximum permissible DC with inductance decrease $\Delta L/L_0 \le 10\%$ and temperature increase of ≤ 45 K at rated temperature				
Measured with network analyzer Agilent 8753D, 20 °C				
Measured at 20 °C				
Sn95.5Ag3.8Cu0.7: (245 \pm 5) °C, (5 \pm 0.3) s Wetting of soldering area \geq 90% (based on IEC 60068-2-58)				
260 °C, 40 s (as referenced in JEDEC J-STD 020C)				
55/150/56 (to IEC 60068-1)				
Mounted: -55°C +150 °C Packaged: -25 °C +40 °C, ≤ 75% RH				
Approx. 50 mg				



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Characteristics and ordering codes

L_{R}	Tolerance	fL	Q _{min}	f_Q	I _R	R _{max}	f _{res,min}	Ordering code ¹⁾²⁾
μΗ		MHz		MHz	mA	Ω	MHz	(Ø 180-mm reel)
0.10	±20% ≙ M	10	10	2.52	2050	0.03	1000	B82422H1101M000
0.15		10	10	2.52	1880	0.04	800	B82422H1151M000
0.22		10	10	2.52	1760	0.04	600	B82422H1221M000
0.33		10	10	2.52	1650	0.05	500	B82422H1331M000
0.47		7.96	10	2.52	1540	0.05	400	B82422H1471M000
0.68		7.96	10	2.52	1370	0.07	200	B82422H1681M000
1.0	±5% ≙ J	7.96	10	2.52	1270	0.09	150	B82422H1102+000
1.5	±10% ≙ K	7.96	10	2.52	1120	0.12	110	B82422H1152+000
2.2		7.96	10	2.52	1000	0.15	90	B82422H1222+000
3.3		7.96	10	2.52	840	0.20	70	B82422H1332+000
4.7		7.96	10	2.52	770	0.24	46	B82422H1472+000
6.8		7.96	10	2.52	660	0.33	35	B82422H1682+000
10		2.52	12	2.52	500	0.46	30	B82422H1103+000
15		2.52	12	2.52	390	0.72	26	B82422H1153+000
22		2.52	12	2.52	330	1.0	21	B82422H1223+000
33		2.52	15	2.52	280	1.4	15	B82422H1333+000
47		2.52	15	2.52	230	2.1	12	B82422H1473+000
68		2.52	15	2.52	180	3.4	10	B82422H1683+000
100		0.796	20	0.796	150	4.8	8.0	B82422H1104+000
150		0.796	20	0.796	120	7.5	6.0	B82422H1154+000
220		0.796	20	0.796	100	10.9	5.5	B82422H1224+000
330		0.796	20	0.796	90	13.0	4.5	B82422H1334+000
470		0.796	20	0.796	76	20.0	3.5	B82422H1474+000
680		0.796	20	0.796	61	31.0	3.0	B82422H1684+000

Intermediate values and closer tolerances on request.

Higher currents possible at temperatures <T $_R$ on request.

Sample kit available. Ordering code: B82422X002 For more information refer to chapter "Sample kits".

¹⁾ Replace the + by the code letter for the required inductance tolerance.

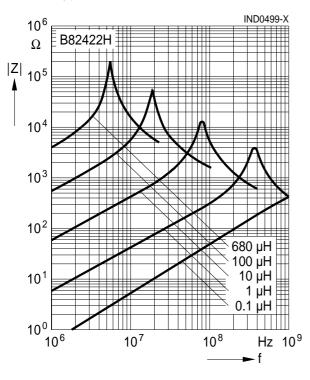
For reel size Ø 330 mm the last digit has to be an »8«. Example: B82422H1102M008
2) For Ni-barrier-plated terminals replace the last two digits "00" by "50" (reel 180 mm) or "58" (reel 330 mm).



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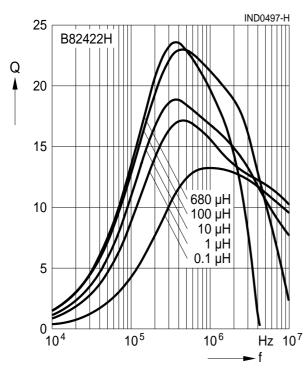
Impedance |Z| versus frequency f

measured with impedance analyzer Agilent 4294A, typical values at 20 °C



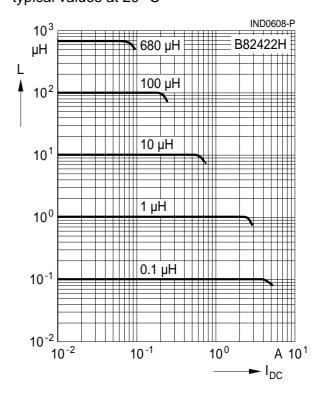
Q factor versus frequency f

measured with impedance analyzer Agilent 4294A, typical values at 20 °C



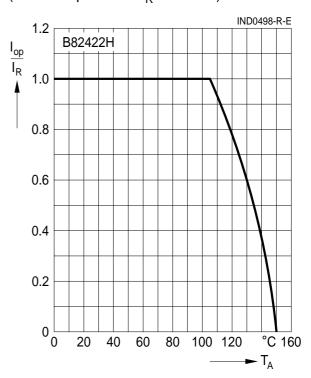
SMD

Inductance L versus DC load current I_{DC} measured with LCR meter Agilent 4284A, typical values at 20 °C



Current derating I_{op}/I_R versus ambient temperature T_A

(rated temperature $T_R = 105 \, ^{\circ}\text{C}$)





Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.



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